

STS8DNF3LL

Dual N-channel 30V - 0.017Ω - 8A SO-8 Low gate charge STripFET™ II Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS8DNF3LL	30V	<0.020Ω	8A

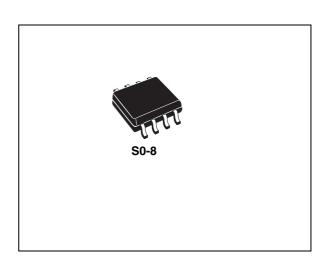
- Optimal R_{DS}(on) x Qg trade-off @ 4.5V
- Conduction losses reduced
- Switching losses reduced

Description

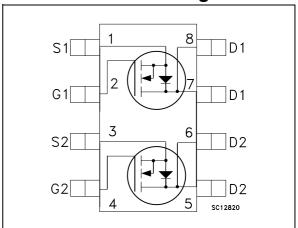
This application specific Power MOSFET is the second generation of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. When used as high and low side in buck regulators, it gives the best performance in terms of both conduction and switching losses. This is extremely important for motherboards where fast switching and high efficiency are of paramount importance.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Part number Marking Package		Packaging
STS8DNF3LL	S8DNF3LL	SO-8	Tape & reel

Contents STS8DNF3LL

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STS8DNF3LL Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (v _{gs} = 0)	30	V
V _{GS}	Gate- source voltage	±16	V
I _D	Drain current (continuos) at T _C = 25°C single operating	8	Α
I _D	Drain current (continuos) at T _C = 100°C single operating	5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	32	Α
P _{TOT}	Total dissipation at $T_C = 25^{\circ}C$ dual operating Total dissipation at $T_C = 25^{\circ}C$ single operating	2 1.6	W W

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

R _{thj-a}	(1)Thermal resistance junction-ambient single operating Thermal resistance junction-ambient dual operating	78 62.5	°C/W
T _J	Thermal operating junction-ambient	150	°C
T _{stg}	Storage temperature	-55 to 150	°C

^{1.} Mounted on FR-4 board with 0.5 in² pad of Cu.

Electrical characteristics STS8DNF3LL

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			٧
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} =Max rating, T_{C} =125°C			1 10	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 16V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 4A$ $V_{GS} = 4.5V, I_D = 4A$		0.017 0.020	0.020 0.024	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D = 4 A		12.5		S
C _{iss}	Input capacitance			800		pF
C_{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$		250		pF
C_{rss}	Reverse transfer capacitance	$V_{GS} = 0$		60		pF
Qg	Total gate charge	V _{DD} = 15V, I _D = 8A,		12.5	17	nC
Q_{gs}	Gate-source charge	$V_{DD} = 15V, I_D = 8A,$ $V_{GS} = 5V$		3.2		nC
Q_{gd}	Gate-drain charge	(see Figure 14)		4.5		nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =15 V, I_{D} =4A, R_{G} =4.7 Ω , V_{GS} = 4.5V (see Figure 13)		18 32		ns ns
t _{d(off)}	Turn-off Delay Time Fall Time	V_{DD} =15 V, I_{D} =4A, R_{G} =4.7 Ω , V_{GS} = 4.5V (see Figure 13)		21 11		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current				8	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				32	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 8A, V _{GS} = 0			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 8A, V_{DD} = 15V$ di/dt = 100A/ μ s, $T_{j} = 150$ °C (see Figure 15)		23 17 1.5		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STS8DNF3LL

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

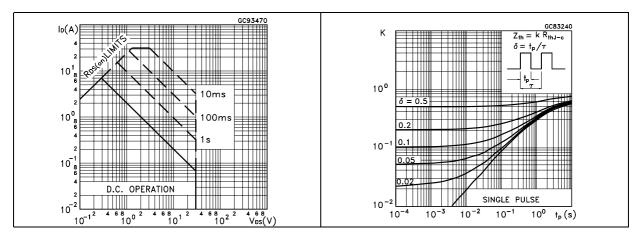


Figure 3. Output characteristics

Figure 4. Transfer characteristics

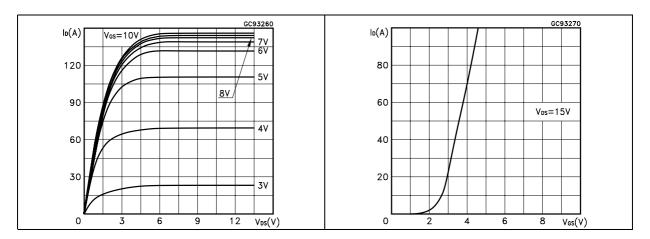


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

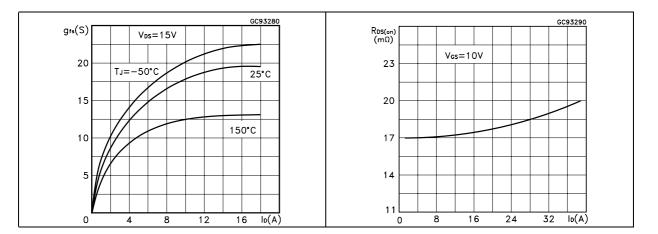


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

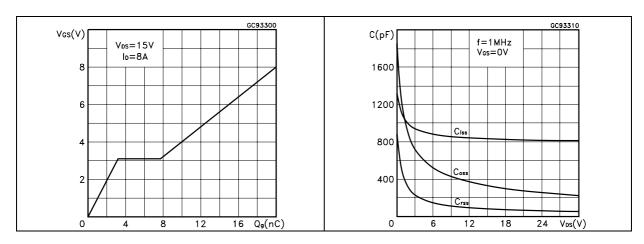


Figure 9. Normalized gate threshold voltage vs. temperature

Figure 10. Normalized on resistance vs. temperature

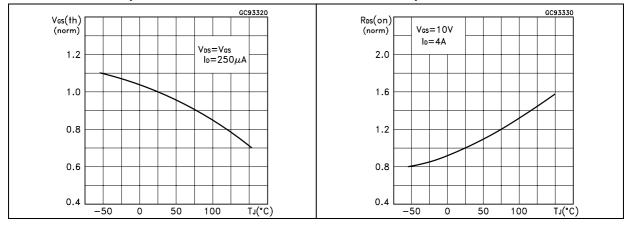
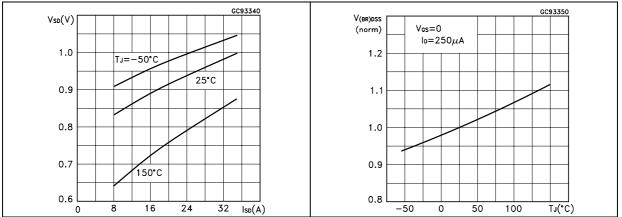


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs. temperature



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Test circuit STS8DNF3LL

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

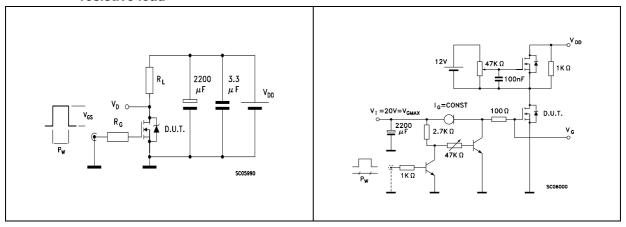


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

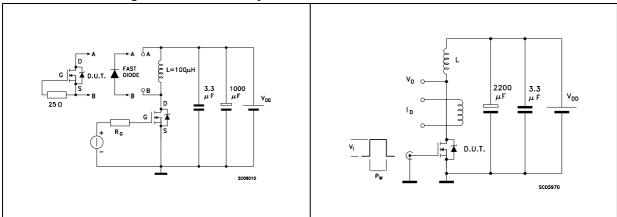
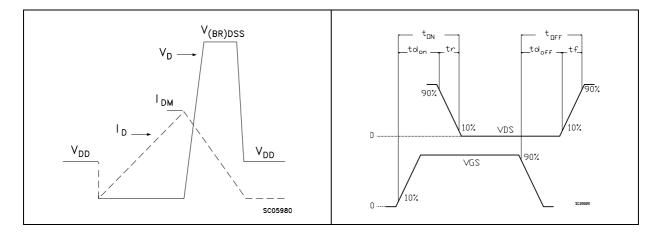


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

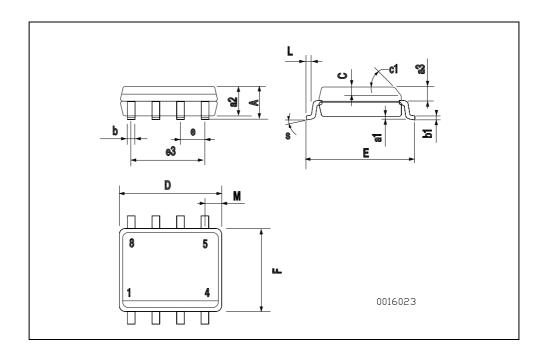


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SO-8 MECHANICA	L DA1	Ά
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DIM.		mm. inch			inch	
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
аЗ	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
е3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (r	nax.)	•	•



STS8DNF3LL Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
11-Sep-2006	8	Complete document
15-Nov-2006	9	The document has been reformatted
30-Jan-2007	10	Typo mistake on <i>Table 1</i> .

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